Supplementary Information

Nano-Architecture of nitrogen-doped graphene films

synthetized from a solid CN source

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Label	Sample	N2 pressure	DC bias	N at.%	N at.%
		(Pa)	(V)	a-C:N	N-doped graphene
Graphene	a-C / Ni / SiO ₂	0	0	0	0
NG1	a-C:N / Ni / SiO ₂	0.5	0	4	2.0
NG2	a-C:N / Ni / SiO ₂	1	0	10	2.2
NG3	a-C:N / Ni / SiO ₂	10	0	16	2.4
NG4	a-C:N / Ni / SiO ₂	5	-250 V	21	2.9

Table S1 Synthesis conditions and nitrogen contents

Table S1: The depositions conditions and N concentrations deduced from XPS in the a-C:N films (before Ni thin film deposition and thermal annealing) and in the N-doped graphene. The thicknesses of the a-C(:N) and Ni films are systematically 10 nm and 150 nm, respectively. One sample without N incorporation is used as reference.

Table S2Chemistry of carbon in the graphene films

C1s component (%)	C _{Gr}	CB	C _{Dis}	C _N	Co
Graphene	69	29	2	-	-
NG1	41	39	6	11	3
NG2	41	42	5	10	3
NG3	44	40	4	10	2
NG4	45	37	4	11	3

Table S2: The assignation of the C1s components from XPS are based on ¹.

N1s component (%)	N pyridinic	N pyrrolic	N quaternary	N pyridinic oxide	
NG1	35	17	20	28	
NG2	41	14	24	21	
NG3	36	17	22	25	
NG4	38	16	21	25	

Table S3Chemistry of nitrogen in the graphene films

Table S3: The assignation of the N1s components from XPS are based on ¹.

Angular-Resolved XPS applied to the quantification of the graphene layers number

Considering these two assumptions and according to work of Tyagi et al.², the total intensity of the C1s peak can be written as follow:

$$I_T = I_{SLG} + I_{2L} + \dots + I_F$$
 (2)

where I_{SLG} is the intensity from a single layer graphene, I_{nL} is the intensity from the n layer graphene and I_F is the intensity from the fractional layer on the top of the graphene film. The intensities I_{SLG} and I_{nL} can be described by the following equations 3 and 4:

$$I_{SLG} = I_{HOPG} \times \left[1 - \exp\left(\frac{-d_{SLG}}{\lambda_{C1s}^{graphene} \cos\theta}\right) \right]$$
(3)

$$I_{nL} = I_{HOPG} \times \left[e^{-\frac{(n-1)d_{SLG}}{\lambda_{C1s}^{graphene}\cos\theta}} - e^{-\frac{nd_{SLG}}{\lambda_{C1s}^{graphene}\cos\theta}} \right]$$
(4)

where $d_{SLG} = 3.35$ Å is the thickness of one monolayer, I_{HOPG} the intensity of C1s measured on a pure HOPG standard sample and $\lambda_{C1s}^{graphene}$ the electron attenuation length in graphene. For $\lambda_{C1s}^{graphene}$, we chose the values dependent on electron take-off angles measured by Tyagi et al. on single layer graphene grown on Cu foil. For the four electron take-off angles in the range of 28° to 58° used to estimate the average thickness of graphene films, the electron attenuation length varies slightly from 1 nm to 1.4 nm.

Then, following the step-wise growth model, the average thickness of graphene films is calculated for each electron take-off angle iteratively using the steps indicated below:

if $I_T - I_{SLG} < I_{2L}$ then number of layers $= 1 + \frac{I_T - I_{SLG}}{I_{2L}}$ with $I_F = \frac{I_T - I_{SLG}}{I_{2L}}$ if $I_T - I_{SLG} - I_{2L} < I_{3L}$ then number of layers $= 2 + \frac{I_T - I_{SLG} - I_{2L}}{I_{3L}}$ with $I_F = \frac{I_T - I_{SLG} - I_{2L}}{I_{3L}}$

To check the first assumption, the narrow scans of Ni2p_{3/2} peak at different photoelectron emission angles were carried out. The **Figure S1** shows Ni2p_{3/2} spectra acquired on the sample NG4 at an emission angle close to the normal of the sample figure 1a) and for a grazing angle figure 1b). In the case of grazing angle, the component with a shape derived from measurement on pure ion cleaned Ni standard sample does not describe correctly the experimental shape of Ni2p_{3/2} spectrum. Two other components consisting in principal peak with an associated satellite were added in order to fit the shape of the Ni2p_{3/2} spectrum. The adjustment to the experimental spectrum gave a ratio of the intensities of satellite to principal peak of 0.4 as well as a shift of 5.6 eV between these peaks which corresponds to Ni(OH)₂ as referred to ³. If we assume that Ni(OH)₂ is formed at room temperature where Ni is not covered by graphene layers, the surface covering ratio of Ni(OH)₂ is good indicator of the graphene film coverage.



Figure S1: $Ni2p_{3/2}$ peak measured on NG4 sample for two photoelectron emission angles with respect to the normal of the sample: a) 28° and b) 68°.

The two components associated to $Ni(OH)_2$ determined at the electron emission angle of 68° were used to adjust the $Ni2p_{3/2}$ spectra at others photoelectron emission angles. The intensities ratio of Ni and $Ni(OH)_2$ components can be then described as:

$$\frac{INi2p_{3/2}^{Ni(OH)_2}}{INi2p_{3/2}^{Ni}} = \frac{\frac{\lambda_{Ni2p_{3/2}}^{Ni} \times \alpha \times \left(1 - \exp\left(\frac{-d^{Ni(OH)_2}}{\lambda_{Ni2p_{3/2}}^{Ni(OH)_2}\cos\theta}\right)\right)}{\left(1 - \alpha\right) \times \exp\left(\frac{-d^{graphene}}{\lambda_{Ni2p_{3/2}}^{graphene}\cos\theta}\right) + \alpha \times \exp\left(\frac{-d^{Ni(OH)_2}}{\lambda_{Ni2p_{3/2}}^{Ni(OH)_2}\cos\theta}\right)$$
(5)

where α is the surface coverage of Ni(OH)₂, $d^{Ni(OH)_2}$ the thickness of Ni(OH)₂ film, $d^{graphene}$ the thickness of the graphene film determined with the stepwise model, $\lambda_{Ni2P_{3/2}}^{Ni(OH)_2}$, $\lambda_{Ni2P_{3/2}}^{Ni}$ and $\lambda_{Ni2P_{3/2}}^{graphene}$ the attenuation lengths of electron coming from the Ni2p_{3/2} core level and travelling respectively through Ni(OH)₂, Ni and graphene materials. $\lambda_{Ni2P_{3/2}}^{Ni(OH)_2}$ and $\lambda_{Ni2P_{3/2}}^{Ni}$ were determined with the TPP2M method ⁴ and gave respectively 1.3 and 1.1 nm and $\lambda_{Ni2P_{3/2}}^{graphene}$ was estimated to 1.1 nm ⁵. Figure S2 presents the result of the adjustment of the theoretical ratio given by equation 4 and the experimental which are in good accordance. A 3% surface coverage of Ni(OH)₂ was found which suggests that the graphene film covers almost entirely the surface and validates the first assumption. Similar results were found for the others nitrogen doped graphene films.



Figure S2: experimental and theoretical intensities ratio of $Ni2p_{3/2}$ peak for Ni and $Ni(OH)_2$ in function of the photoelectron emission angle. The adjustment of the model given by equation 4 gave a $Ni(OH)_2$ film with a thickness of 0.48 nm and a surface coverage of 3%.

Auger Electron Spectroscopy Mapping

AES mapping of nitrogen doped graphene films were performed on $10x10 \ \mu m^2$ area with scanning rate of 56x56 points. For each point, narrow scans of C KLL and Ni L₃M_{4,5}M_{4,5} transitions were sequentially recorded. These transitions were also acquired on HOPG and pure Ni standard samples in equivalent experimental conditions. As shown in the **Figure S3**, the spectra were after acquisition numerically derived and the intensities of each transitions were measured as a peak to peak eight.



Figure S3: measurement of the intensities of C KLL and Ni $L_3M_{4,5}M_{4,5}$ transitions after derivation of experimental narrows scans. Each narrow scan were sequentially recorded for each point of the Auger Mapping on an area of 10 X 10 μ m² with a scan rate of 56 X 56 points.

Considering a model of a substrate with an overlayer film, the ratio of the intensities of C KLL and Ni $L_3M_{4,5}M_{4,5}$ can be expressed as:

$$\frac{I_{C_{KLL}}}{I_{Ni_{L_{3}M_{45}M_{45}}}} = \frac{I^{std}_{C_{KLL}}}{I^{std}_{Ni_{L_{3}M_{45}M_{45}}}} \times \frac{1 - \exp\left(-\frac{n \times d^{SLG}}{\lambda_{C_{KLL}}^{graphene}}\right)}{\exp\left(-\frac{n \times d^{SLG}}{\lambda_{Ni_{L_{3}M_{45}M_{45}}}^{graphene}}\right)}$$
(6)

where $d_{SLG} = 3.35$ Å is the thickness of one graphene monolayer, $I^{std}_{C_{KLL}}$ and $I^{std}_{Ni_{L3M_{45}M_{45}}}$ the intensities measured on HOPG and pure Ni standard samples and *n* the numbers of graphene layers. The attenuation lengths of electron coming from C KLL and Ni L₃M_{4,5}M_{4,5} transitions and travelling through graphene layers were taken as $\lambda_{C_{KLL}}^{graphene} = 7$ Å and $\lambda_{Ni_{L3M_{45}M_{45}}}^{graphene} = 14$ Å according to ⁴. For each points of the Auger mapping, the number of graphene layers was then

calculated iteratively until the theoretical intensities ratio given by equation 6 matches the experimental one.

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